

## PQ1CX22H2ZPQ

Low Output Bootstrap system  
Chopper Regulator

### Features

- 1.Low output voltage :MIN.1.2V
- 2.Maximum switching current: 2.5A
- 3.High efficiency(efficiency : 88%[ $V_{IN}=5V, V_{OUT}=3.3V$ ])
- 4.Built-in oscillation circuit  
(Oscillation frequency:TYP.150kHz)
- 5.Built-in overheat, overcurrent protection functions
- 6.RoHS directive compliant

### Applications

- 1.AV equipment
- 2.Digital OA equipment

### Absolute Maximum Ratings

( $T_a=25^\circ\text{C}$ )

Parameter	Symbol	Rating	Unit
*1 Input voltage	$V_{IN}$	33	V
*2 Boost terminal voltage	$V_B$	33	V
*3 Voltage between $V_B$ and $V_{IN}$	$V_{B-I}$	15	V
Malfunction input voltage	$V_{ADJ}$	7	V
Input-output voltage	$V_{I-O}$	34	V
*4 Output-GND voltage	$V_{OUT}$	-1	V
*5 ON/OFF control voltage	$V_C$	-0.3 to 20	V
Switching current	$I_{SW}$	2.5	A
*6 Power dissipation	$P_d$	0.9	W
*7 Junction temperature	$T_j$	150	$^\circ\text{C}$
Operating temperature	$T_{opr}$	-40 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +150	$^\circ\text{C}$
Soldering temperature	$T_{sol}$	260(for 10s)	$^\circ\text{C}$

\*1 Voltage between  $V_{IN}$  and GND

\*2 Voltage between  $V_B$  and GND

\*3 Voltage between  $V_B$  and  $V_{IN}$

\*4 Voltage between  $V_{OUT}$  and GND

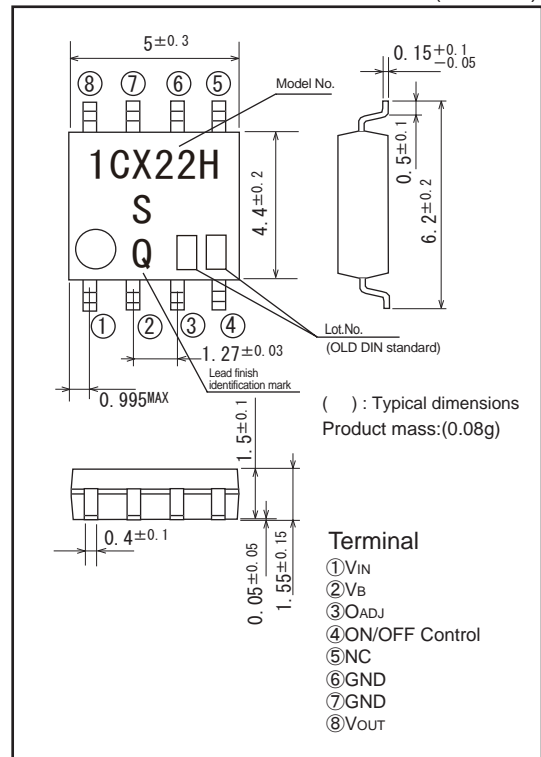
\*5 Voltage between ON/OFF and GND

\*6 At the time of the PCB mounting

\*7 There is case that over heat protection function operates at the temperature  $T_j=125^\circ\text{C}$  to  $150^\circ\text{C}$ , so this item cannot be used in this temperature range.

### Outline Dimensions

(Unit:mm)



( ) : Typical dimensions  
Product mass:(0.08g)

#### Terminal

- ①  $V_{IN}$
- ②  $V_B$
- ③  $O_{ADJ}$
- ④ ON/OFF Control
- ⑤ NC
- ⑥ GND
- ⑦ GND
- ⑧  $V_{OUT}$

Lead finish:Lead-free solder plating  
(Composition: Sn2Bi)

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## Electrical Characteristics

(Unless otherwise specified, condition shall be  $V_{IN}=5V, I_o=0.5A, V_o=3.3V, ON/OFF$  terminal : Open,  $T_a=25^\circ C$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input-output voltage ratio	DI-O1	$V_{IN} > 14V$	15	-	-	%
	DI-O2	$V_{IN} \leq 14V$	8.5	-	-	%
Output saturation voltage	$V_{SAT}$	$I_{sw}=2.0A$	-	0.25	0.4	V
Reference voltage	$V_{REF}$	-	0.975	1.0	1.025	V
Load regulation	RegL	$I_o=0.5$ to 2.0A	-	0.2	1.5	%
Line regulation	Regl	$V_{IN}=5$ to 20V	-	1	2.5	%
Efficiency	$\eta$	$I_o=2.0A$	-	88	-	%
Oscillation frequency	$f_o$	-	135	150	165	kHz
Overcurrent detection level	$I_L$	Switching current peak	2.55	3.2	4.2	A
Maximum duty	$D_{MAX}$	3pin = 0.9V	83	90	-	%
Charge current	$I_{CHG}$	3,8 pin :Open, 4 pin	-	-10	-	$\mu A$
Input threshold voltage	$V_{THL}$	Duty=0 %, 3pin=0V, 4pin	-	1.3	-	V
	$V_{THH}$	Duty= $D_{MAX}$ , 3pin :Open, 4pin	-	2.3	-	V
ON threshold voltage	$V_{THON}$	3pin=0V, 4pin	0.7	0.8	0.9	V
Standby-current	$I_{SD}$	$V_{IN}=33V, 4pin=0V$	-	120	400	$\mu A$
Output OFF-state consumption current	$I_{QS}$	$V_{IN}=33V, 4pin=0.9V$	-	6	10	mA
Minimum Input Voltage	$V_{IN(MIN)}$	-	-	-	4.5	V
Minimum Boost Voltage	$V_{BOOST(MIN)}$	Voltage between $V_b$ terminal and $V_{OUT}$ terminal	-	-	3	V

Fig.1 Test Circuit

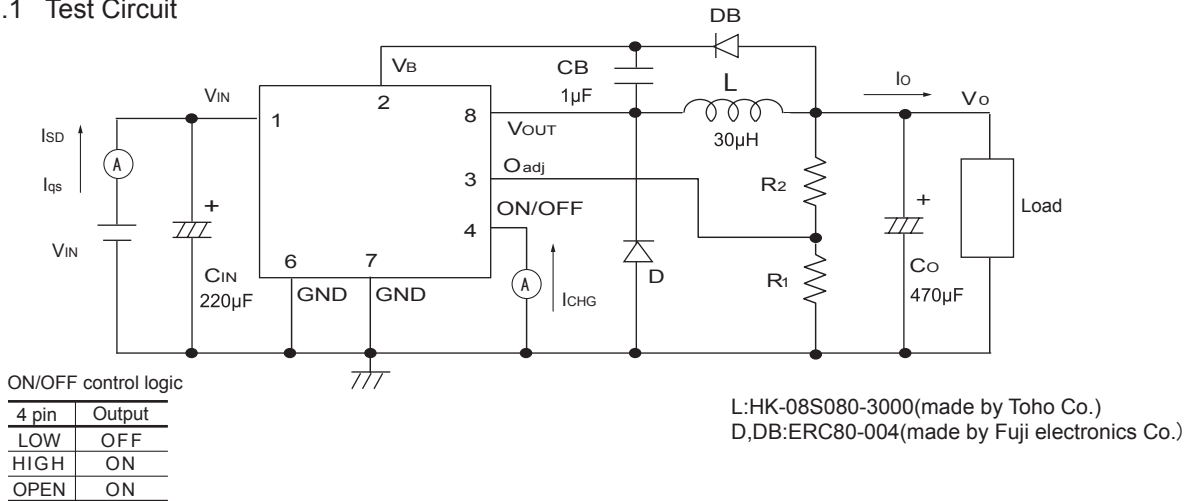
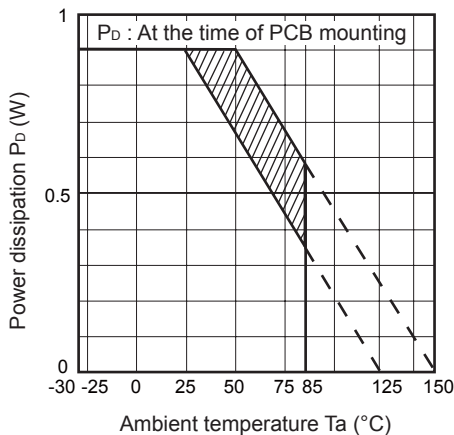


Fig.2 Power Dissipation vs.Ambient Temperature



Note) Oblique line portion: Overheat protection may operate in this area

Fig.3 Overcurrent Protection Characteristics (Typical Value)

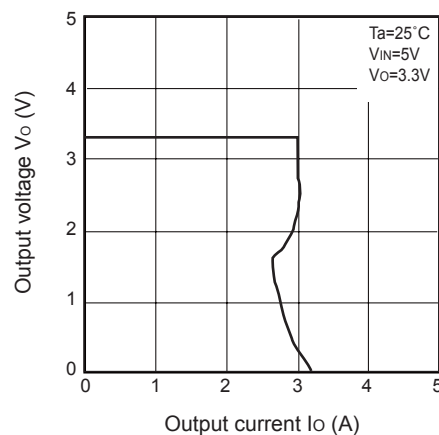


Fig.4 Efficiency vs. Input Voltage

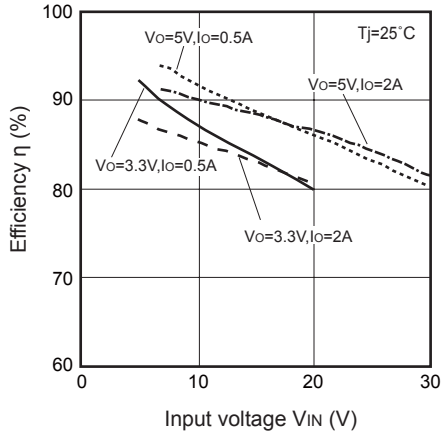


Fig.5 Output Saturation Voltage vs. Switching Current

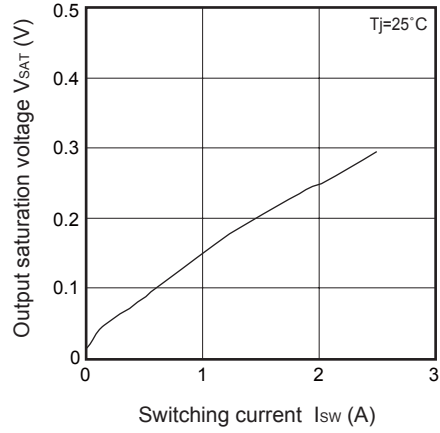


Fig.6 Reference Voltage Fluctuation vs. Junction Temperature

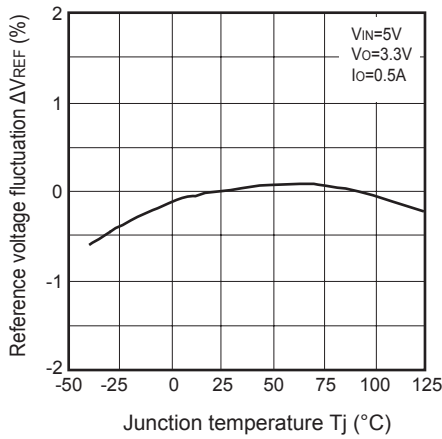


Fig.7 Oscillation Frequency Fluctuation vs. Junction Temperature

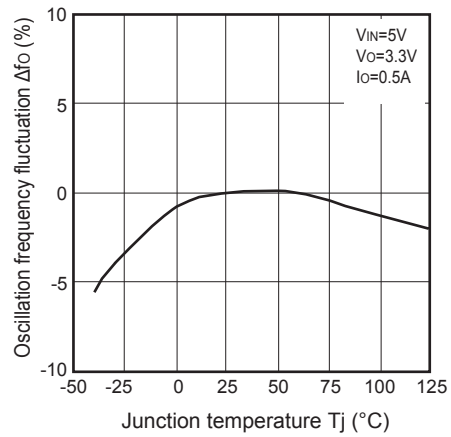


Fig.8 Overcurrent Detecting Level Fluctuation vs. Junction Temperature

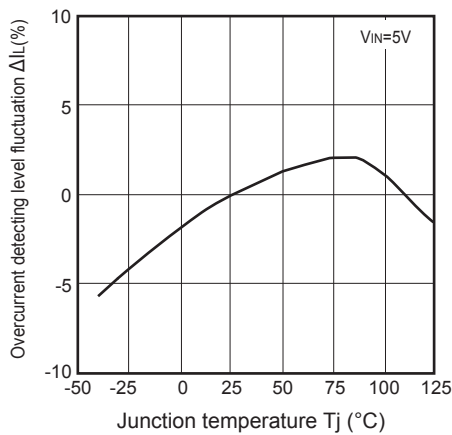


Fig.9 Output Saturation Voltage vs. Voltage between VB and VOUT

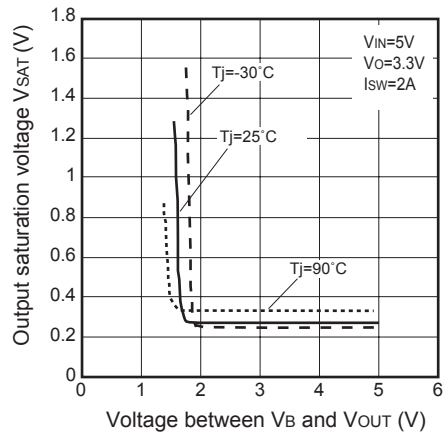


Fig.10 Operating Dissipation Current vs. Input Voltage

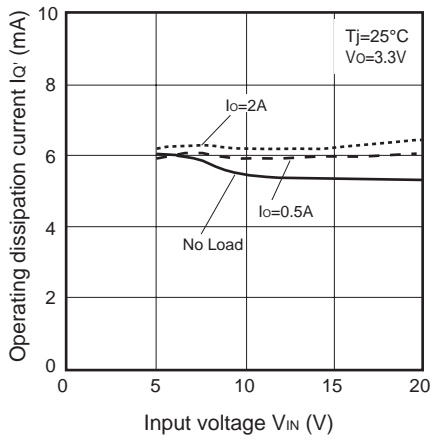


Fig.11 Line Regulation vs. Input Voltage

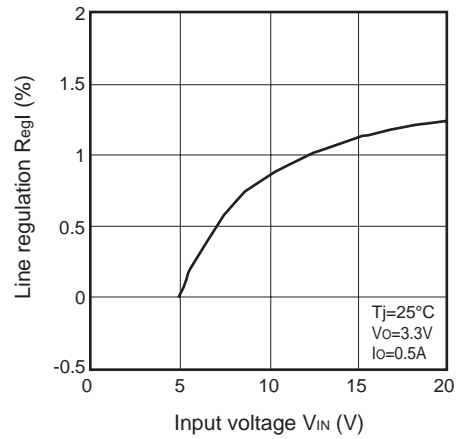


Fig.12 Load Regulation vs. Output Current

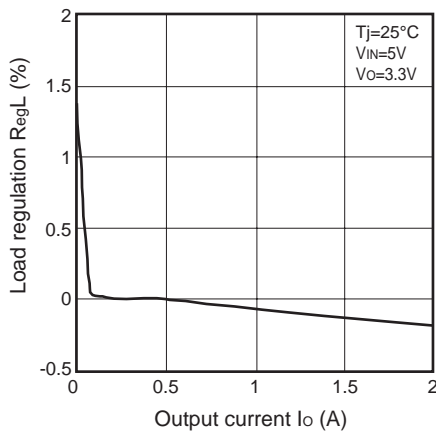


Fig.13 Threshold Voltage vs. Junction Temperature

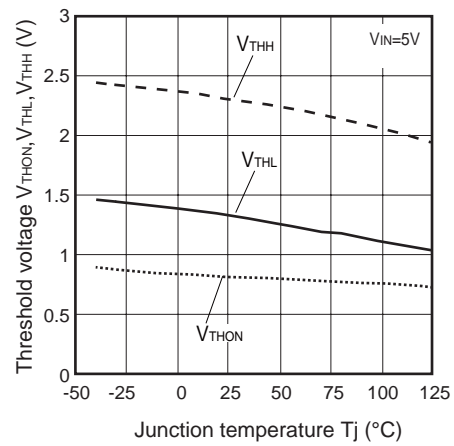


Fig.14 Maximum Duty vs. Junction Temperature

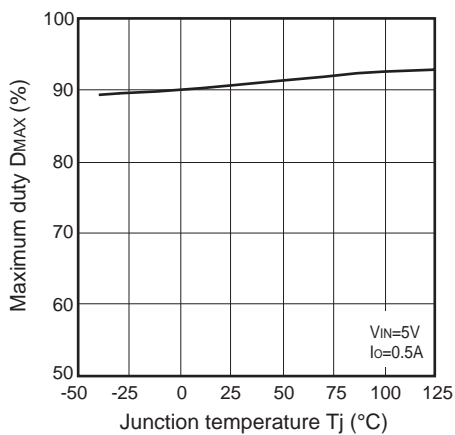


Fig.15 V\_B Terminal Current vs. Switching Current

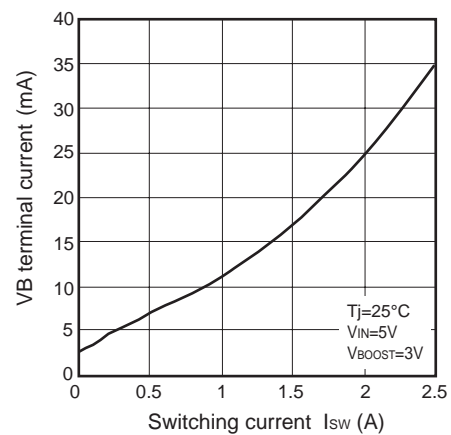
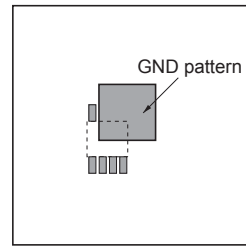
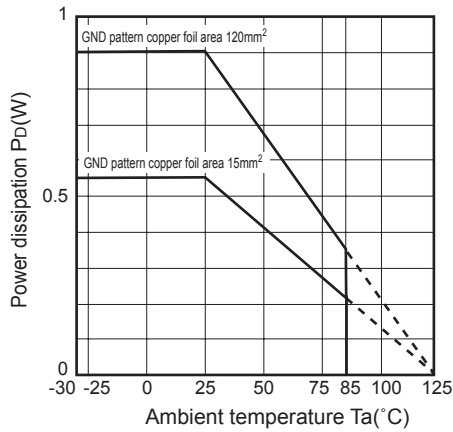


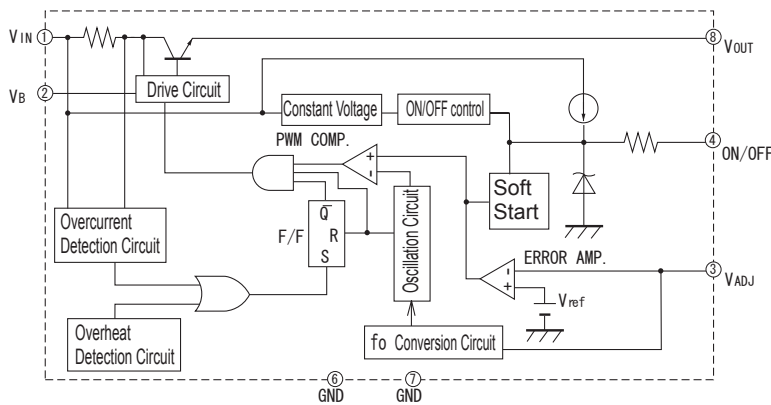
Fig.16 PD-Ta rating(Typical value)



Mounting PCB

Material : Glass-cloth epoxy resin  
 Size : 30mm × 30mm × 1mm  
 GND pattern copper foil area : 120mm<sup>2</sup>,35μm

■ Block Diagram



■ Step-down voltage output circuit diagram

